



# **Dual N-Channel 30-V (D-S) MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)		
30	0.035 at V <sub>GS</sub> = 10 V	6.9	4.5 nC		
30	0.051 at V <sub>GS</sub> = 4.5 V	5.7	4.5110		

#### **FEATURES**

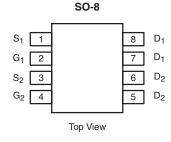
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET
- Compliant to RoHS Directive 2002/95/EC

# Pb-free RoHS

# ROHS COMPLIANT HALOGEN FREE

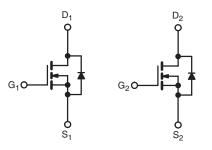
#### **APPLICATIONS**

- Low Current DC/DC Conversion
- Notebook System Power



Ordering Information: Si4936BDY-T1-E3 (Lead (Pb)-free)

Si4936BDY-T1-GE3 (Lead (Pb)-free and Halogen-free)



N-Channel MOSFET

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T <sub>A</sub> = 25 °C, unless otherwise noted						
Parameter		Symbol	Limit	Unit		
Drain-Source Voltage		$V_{DS}$	30	V		
Gate-Source Voltage		$V_{GS}$	± 20	v		
	T <sub>C</sub> = 25 °C	I <sub>D</sub>	6.9			
Continuous Drain Current (T <sub>.I</sub> = 150 °C)	T <sub>C</sub> = 70 °C		5.5			
Continuous Diain Current (1) = 130 C)	T <sub>A</sub> = 25 °C		5.9 <sup>a, b</sup>			
	T <sub>A</sub> = 70 °C		4.7 <sup>a, b</sup>	Α		
Pulsed Drain Current	•	I <sub>DM</sub>	30			
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	I <sub>S</sub>	2.3			
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C		1.7 <sup>a, b</sup>			
	T <sub>C</sub> = 25 °C		2.8			
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	1.8	w		
	T <sub>A</sub> = 25 °C		2 <sup>a, b</sup>	VV		
	T <sub>A</sub> = 70 °C	1	1.3 <sup>a, b</sup>			
Operating Junction and Storage Temperature	Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 10 s	R <sub>thJA</sub>	58	62.5	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	$R_{thJF}$	38	45			

#### Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Maximum under Steady State conditions is 110 °C/W.

## Si4936BDY

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static					L		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 050A		26.5		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 5.6			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_{D} = 250 \mu A$	1.5		3	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	ns	
7 0	,	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V			1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			10	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α	
_	5	$V_{GS} = 10 \text{ V}, I_D = 5.9 \text{ A}$	0.029		0.035		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 4.9 \text{ A}$		0.042	0.051	Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 10 \text{ V}, I_D = 5.9 \text{ A}$		12		S	
Dynamic <sup>b</sup>	L			L			
Input Capacitance	C <sub>iss</sub>			530		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		100			
Reverse Transfer Capacitance	C <sub>rss</sub>			55			
Total Cata Chargo	$Q_g$	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5.9 \text{ A}$		9.1	15		
Total Gate Charge	€g			4.5	7	nC	
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 5.9 \text{ A}$		1.8			
Gate-Drain Charge	$Q_{gd}$			1.7			
Gate Resistance	$R_g$	f = 1 MHz		3		Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			20	30		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 3.2 $\Omega$		130	195		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D\cong$ 4.7 A, $V_{GEN}$ = 4.5 V, $R_g$ = 1 $\Omega$		12	20		
Fall Time	t <sub>f</sub>			32	50	no	
Turn-On Delay Time	t <sub>d(on)</sub>			5	10	- ns -	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 3.2 $\Omega$		25	40		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D\cong$ 4.7 A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$		12	20		
Fall Time	t <sub>f</sub>			10	15	1	
<b>Drain-Source Body Diode Characteristi</b>	cs				l .		
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			6.9	^	
Pulse Diode Forward Current	I <sub>SM</sub>				30	_ A	
Body Diode Voltage	$V_{SD}$	$I_S = 4.7 \text{ A}, V_{GS} = 0 \text{ V}$		0.8	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			20	40	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	L = 4.7.4 dl/dt = 100.4/ T		12	24	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 4.7 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		11			
Reverse Recovery Rise Time	t <sub>b</sub>			9		ns	

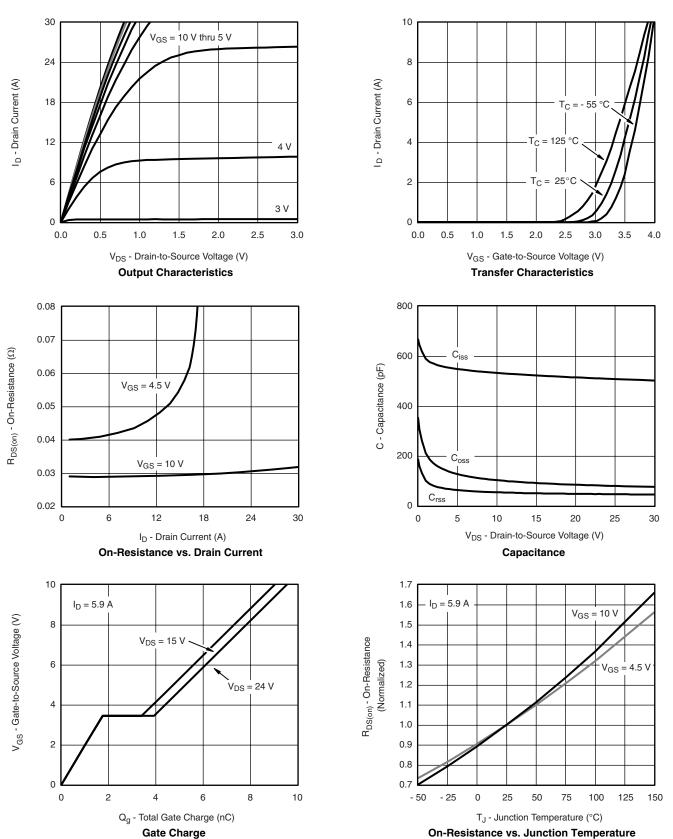
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$ 

b. Guaranteed by design, not subject to production testing.



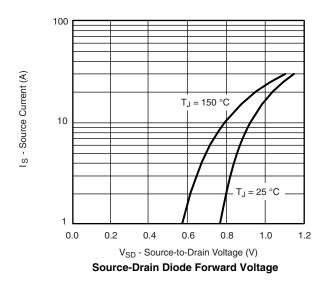
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

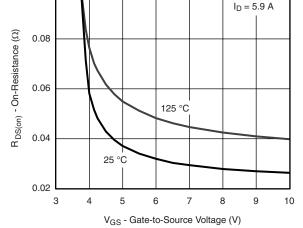


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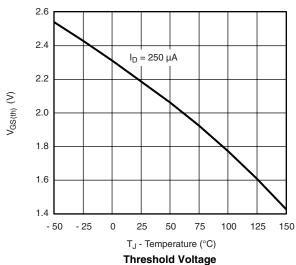
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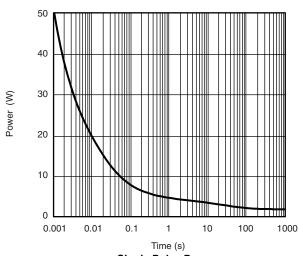




0.10

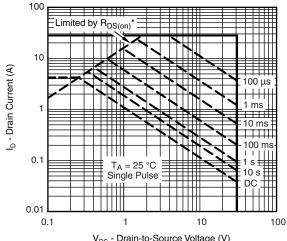






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Single Pulse Power



 $\rm V_{DS}$  - Drain-to-Source Voltage (V) \*  $\rm V_{DS}$  > minimum  $\rm V_{GS}$  at which  $\rm R_{DS(on)}$  is specified

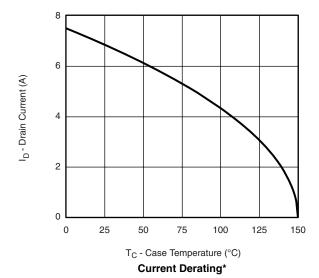
Safe Operating Area, Junction-to-Ambient

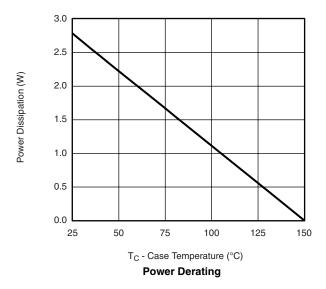




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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



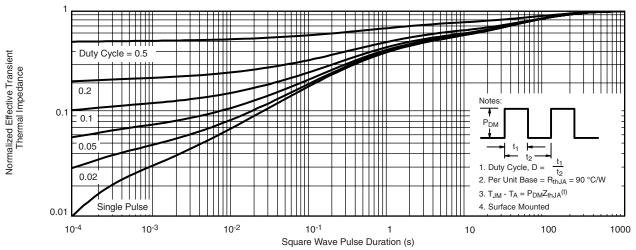


<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

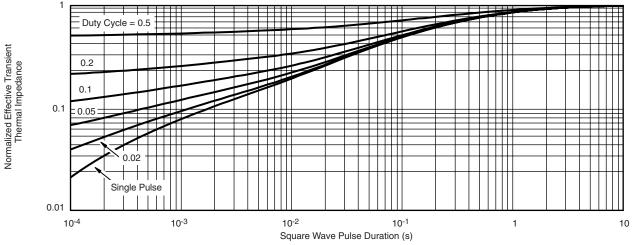
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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?74469">www.vishay.com/ppg?74469</a>.



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INC	INCHES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27 BSC		0.050	0.050 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

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#### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

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